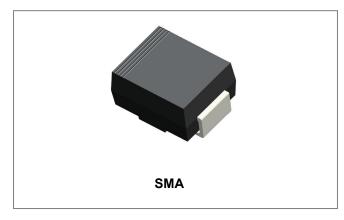






# GS1A THRU GS1M 1.0A SURFACE MOUNT GLASS PASSIVATED RECTIFIER



#### **Features**

- Glass Passivated Die Construction
- Ideally Suited for Automatic Assembly
- Low Forward Voltage Drop
- Low Power Loss
- Built-in Strain Relief
- Plastic Case Material has UL Flammability Classification Rating 94V-0
- This is a Pb Free Device
- "-A" suffix is for Automotive qualified
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

#### **Circuit Diagram**



#### **Mechanical Data**

- Case: SMA molded plastic body
- Terminals: Solder plated, solderable per MIL-STD-750, Method 2026
- Polarity: Color band denotes cathode end
- Mounting Position: AnyWeight: 0.06 grams

#### Maximum Ratings and Electrical Characteristics @T<sub>A</sub>=25°C unless otherwise specified

Characteristic	Symbol	GS1A	GS1B	GS1D	GS1G	GS1J	GS1K	GS1M	Units
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	50	100	200	400	600	800	1000	V
Maximum RMS voltage	V <sub>RMS</sub>	35	70	140	280	420	560	700	V
Average Rectified Output Current @T <sub>L</sub> = 100°C	Io				1.0				Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method)	IFSM	30			Α				
Forward Voltage @ I <sub>F</sub> = 1.0 A	VF				1.10				V
Peak Reverse Current @T <sub>A</sub> = 25°C At Rated DC Blocking Voltage @T <sub>A</sub> = 125°C	I <sub>RM</sub>				5.0 200				μA
Reverse Recovery Time(Note1)	t <sub>rr</sub>				2.5				μS
Typical Junction Capacitance(Note2)	Сл	15			pF				
Typical Thermal Resistance Junction to Lead (Note 3)	R <sub>0JL</sub>	30			°C/W				
Operating and Storage Temperature Range	T <sub>J</sub> ,T <sub>STG</sub>			-65	to +175			_	°C

Note: 1. Reverse recovery condition IF=0.5A, IR=1.0A, Irr=0.25A

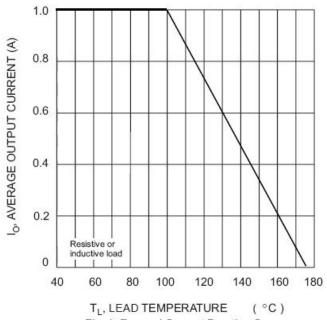
- 2. Measured at 1MHz and applied reverse voltage of 4.0V D.C.
- 3. Mounted on P.C.B.with 8.0mm² land areas.
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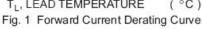


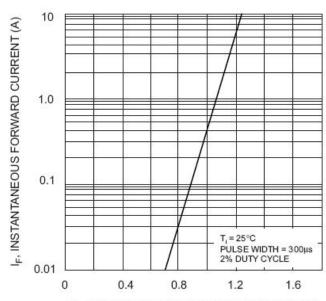




## **Ratings and Characteristics Curves**







V<sub>F</sub>, INSTANTANEOUS FORWARD VOLTAGE (V) Fig. 2 Typical Forward Characteristics

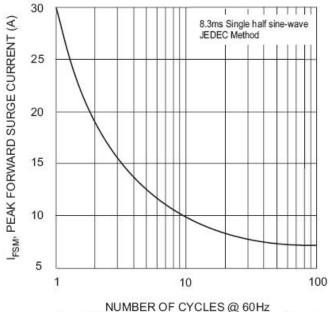
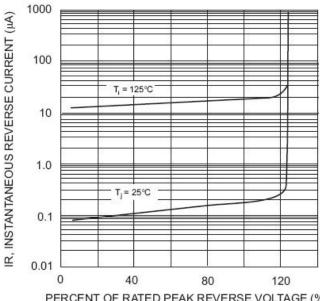


Fig. 3 Max Non-Repetitive Peak Fwd Surge Current



PERCENT OF RATED PEAK REVERSE VOLTAGE (%) Fig. 4 Typical Reverse Characteristics

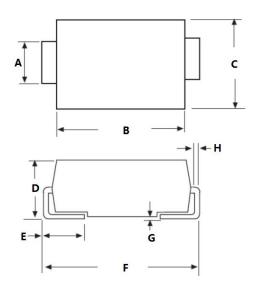
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## **Mechanical Dimensions SMA**



SYMBOL	Millir	neters	Inches		
OTWIDOL	Min.	Max.	Min.	Max.	
Α	1.25	1.65	0.049	0.065	
В	3.95	4.60	0.156	0.181	
С	2.25	2.95	0.089	0.116	
D	1.95	2.90	0.077	0.114	
Е	0.75	1.60	0.030	0.063	
F	4.80	5.60	0.189	0.220	
G	0.05	0.20	0.002	0.008	
Н	0.15	0.41	0.006	0.016	

## **Ordering Information**

Device	Package	Shipping
GS1A-GS1M	SMA	5000pcs / reel
GS1ATR-GS1MTR	SMA	5000pcs / reel

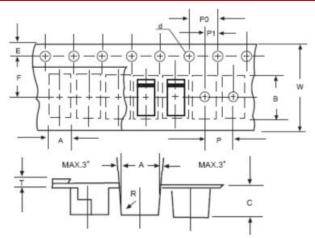
For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

## **Marking Diagram**



First row: Part Number (GS1A, GS1B, GS1D, GS1G, GS1J, GS1K, GS1M) Second row: YYWWL YY is the manufacture year, WW is the manufacture week code, L is the wafer's Lot Number

# **Carrier Tape Specification SMA**



SYMBOL	Millimeters			
	Min.	Max.		
Α	2.97	3.17		
В	5.70	5.90		
С	2.32	2.52		
d	1.40	1.60		
E	1.40	1.60		
F	5.60	5.70		
Р	3.90	4.10		
P0	3.90	4.10		
P1	1.90	2.10		
Т	0.25	0.35		
W	11.80	12.20		

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